TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

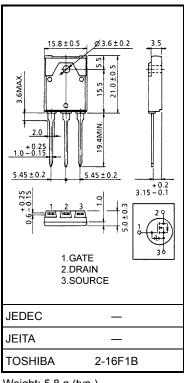
# 2SK3453

#### Switching Regulator Applications

- Low drain-source ON resistance:  $RDS(ON) = 0.72 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 7.0 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 700 \ V)$
- Enhancement model:  $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

#### Absolute Maximum Ratings (Ta = 25°C)

Characte	eristics	Symbol	Rating	Unit	
Drain-source voltage	<u>}</u>	V <sub>DSS</sub>	700	V	
Drain-gate voltage (F	$R_{GS} = 20 \text{ k}\Omega$ )	VDGR	700	V	
Gate-source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	۱ <sub>D</sub>	10	А	
	Pulse (Note 1)	I <sub>DP</sub>	30	А	
Drain power dissipat	ion (Tc = 25°C)	PD	80	W	
Single pulse avalance	he energy (Note 2)	E <sub>AR</sub>	420	mJ	
Avalanche current		I <sub>AR</sub>	10	А	
Repetitive avalanche	e energy (Note 3)	E <sub>AR</sub>	8	mJ	
Channel temperature	5	T <sub>ch</sub>	150	°C	
Storage temperature	range	T <sub>stg</sub>	-55~150	°C	



Weight: 5.8 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	1.56	°C/W	
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	41.6	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$  (initial), L = 7.5 mH, R<sub>G</sub> = 25  $\Omega$ , I<sub>AR</sub> = 10 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

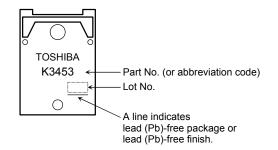
# **Electrical Characteristics (Ta = 25°C)**

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 25~V,~V_{DS}=0~V$	_		±10	μΑ
Drain-source breakdown voltage		V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30		_	V
Drain cut-OFF current		I <sub>DSS</sub>	$V_{DS} = 700 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D=10\ mA,\ V_{GS}=0\ V$	700		—	V
Gate threshold ve	oltage	V <sub>th</sub>	$V_{DS} = 10 \ V, \ I_D = 1 \ mA$	2.0		4.0	V
Drain-source ON	resistance	R <sub>DS (ON)</sub>	$V_{GS}=10~V,~I_D=5~A$		0.72	1.0	Ω
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	4.0	7.0	—	S
Input capacitance		C <sub>iss</sub>	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		1700	—	pF
Reverse transfer capacitance		C <sub>rss</sub>			40	—	
Output capacitance		C <sub>oss</sub>			200		
Switching time	Rise time	tr	$V_{GS}^{10 \text{ V}} \downarrow_{D} = 5 \text{ A } V_{OUT}$	_	40		- ns
	Turn-ON time	t <sub>on</sub>			72	_	
	Fall time	t <sub>f</sub>		_	42	—	
	Turn-OFF time	t <sub>off</sub>		_	145	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 400$ V, $V_{GS} = 10$ V, $I_D = 10$ A		53		nC
Gate-source charge		Q <sub>gs</sub>		_	25	_	
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	28	_	

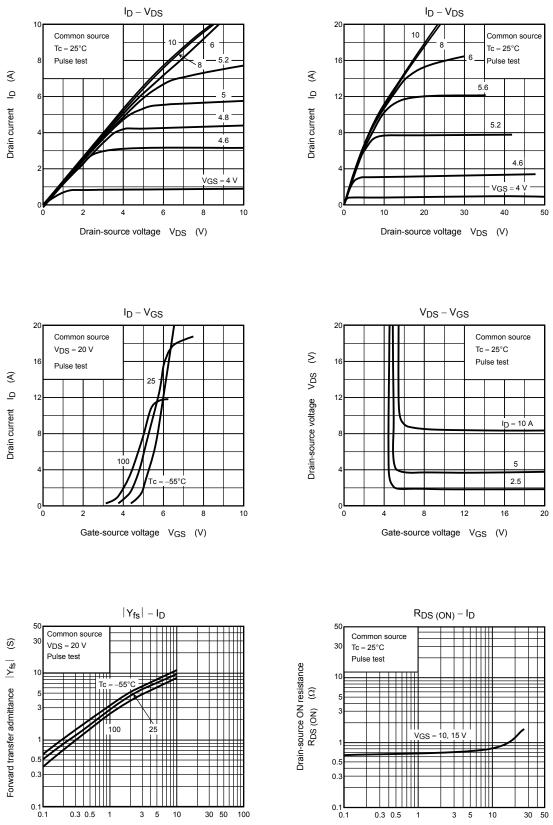
## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	—	10	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_	_	30	А
Forward voltage (diode)	VDSF	$I_{DR} = 10 \text{ A}, V_{GS} = 0 \text{ V}$		_	-1.9	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR} = 10 \text{ A}, V_{GS} = 0 \text{ V},$	_	1400	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dI <sub>DR</sub> /dt = 100 A/µs		17.5	_	μC

## Marking

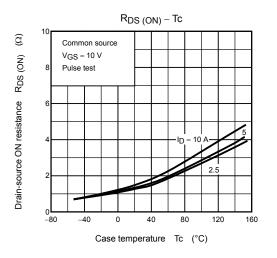


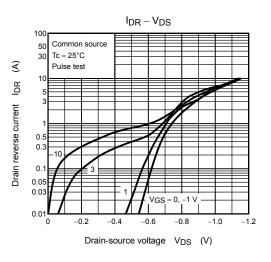
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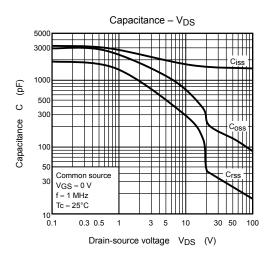


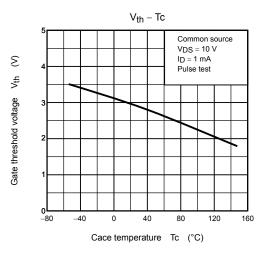
Drain current ID (A)

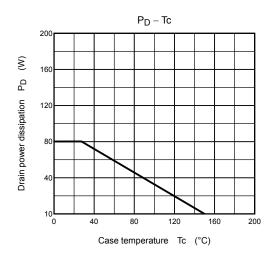
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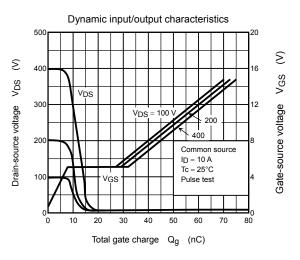


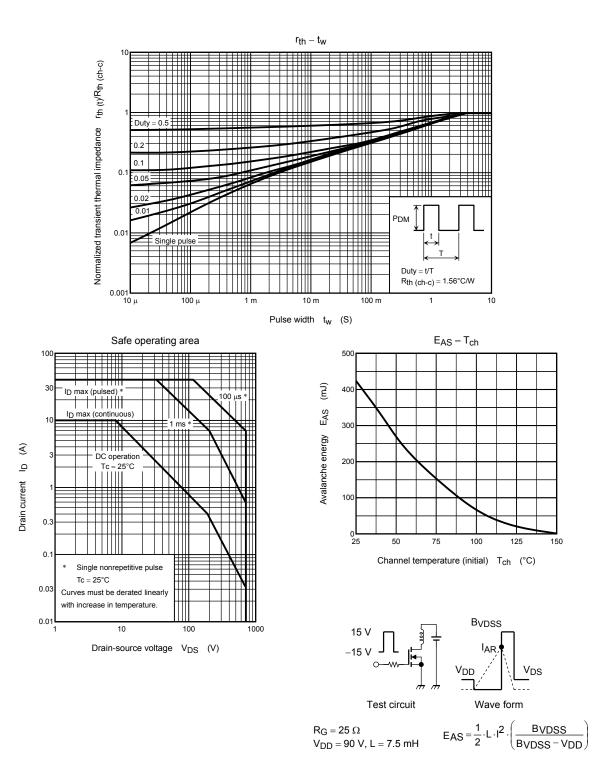












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